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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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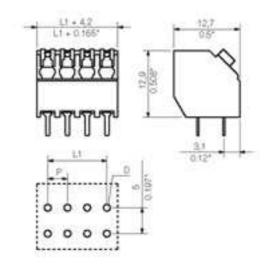
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China















General ordering data	
Order No.	1885600000
Part designation	LSF-SMT3.81/20/135 1.5
Version	PCB terminal, Push In, Reflow solder connection,
	Clamping range, max.: 1.5 mm², Pitch: 3.81 mm,
	No. of poles: 20, 135°, Tube
EAN	4032248490486
Qty.	7 pc(s).

Product family	System LS
Conductor connection system	Push In
Fitted to PCB	Reflow solder connection
Outgoing direction of conductor	135°
Pitch	3.81 mm
Pitch in inch	0.15 inch
No. of poles	20
Fitted by customer	no
No. of rows	1
Solder pin length	1.5 mm
Dia. of fitting hole	1.1 mm
Fitting hole tolerance	+ 0.1 mm
No. of solder pins per pole	2
Stripping length	8 mm



System parameters	
L1 in mm	72.39 mm
L1 in inch	2.85 inch
Electric shock protection to DIN VDE 0470	IP 20
Electric shock protection to DIN VDE 0470	Safe from finger touch
Electric shock protection to bir VBE 0470	Calc Iron inger toden
Material data	
Insulating material	LCP GF
Colour	black
colour chart	Similar to RAL 9011
Insulating material group	Illa
Flammability class UL 94	V-0
CTI	>= 175
Contact base material	Copper alloy
Contact surface	tinned
Storage temperature, min.	-25 °C
Storage temperature, max.	55 °C
Connectable conductors	0.13 mm²
Clamping range, min.	
Clamping range, max.	1.5 mm ²
AWG, min.	24
AWG, max.	16
O.D. of conductor insulation, max.	2.9 mm
Solid, min. H05(07) V-U	0.2 mm ²
Solid, max. H05(07) V-U	1.5 mm²
Flexible, min. H05(07) V-K	0.2 mm ² 1.5 mm ²
Flexible, max. H05(07) V-K	0.25 mm ²
With wire end ferrule, acc. to DIN 46 228/1, min. With wire end ferrule, acc. to DIN 46 228/1, max.	1.5 mm ²
w. plastic collar ferrule, DIN 46228 pt 4, min.	0.25 mm ²
w. plastic collar ferrule, DIN 46228 pt 4, min.	0.75 mm ²
w. plastic collar ferrule, DIN 40220 pt 4, max.	0.73 11111
DIN IEC rating data	
Rated current, min. No. pins (Tu=20°C)	17.5 A
Rated current, max. No. pins (Tu=20°C)	16 A
Rated current, min. No. pins(Tu=40°C)	17.5 A
Rated current, max. No. pins (Tu=40°C)	14 A
Rated voltage for overvoltage class/pollution	320 V
severity II/2	
Rated voltage for overvoltage class/pollution	160 V
severity III/2	
Rated voltage for overvoltage class/pollution	160 V
severity III/3	
Rated impulse withstand voltage for overvoltage	2.5 kV
class/pollution severity II/2	
Rated impulse withstand voltage for overvoltage	2.5 kV
class/pollution severity III/2	
Rated impulse withstand voltage for overvoltage	2.5 kV
class/pollution severity III/3	
Short-time withstand current resistance	3 x 1s with 80 A



CSA rating data	
Rated voltage (Use group D)	300 V
Rated current (Use group D)	10 A
AWG conductor (field wiring), min.	24
AWG conductor (field wiring), max.	16
Rated voltage (Use group D)	300 V
Rated current (Use group D)	10 A
AWG conductor, min.	24
AWG conductor, max.	16

Approvals

Approvals institutes



Classifications

eClass 5.1 27-26-11-01

Similar products

1885880000	LSF-SMT3.81/2/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 2, 135°, Tube
1888320000	LSF-SMT3.81/2/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 2, 135°, Tape
1885410000	LSF-SMT3.81/2/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 2, 135°, Tube
1888450000	LSF-SMT3.81/2/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 2, 135°, Tape
1885890000	LSF-SMT3.81/3/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 3, 135°, Tube
1888330000	LSF-SMT3.81/3/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 3, 135°, Tape
1885420000	LSF-SMT3.81/3/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 3, 135°, Tube
1888460000	LSF-SMT3.81/3/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 3, 135°, Tape
1885900000	LSF-SMT3.81/4/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 4, 135°, Tube
1888340000	LSF-SMT3.81/4/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 4, 135°, Tape
1885430000	LSF-SMT3.81/4/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 4, 135°, Tube
1888470000	LSF-SMT3.81/4/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 4, 135°, Tape

1885910000	LSF-SMT3.81/5/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 5, 135°, Tube
1888380000	LSF-SMT3.81/5/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 5, 135°, Tape
1885440000	LSF-SMT3.81/5/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 5, 135°, Tube
1888480000	LSF-SMT3.81/5/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 5, 135°, Tape
1885920000	LSF-SMT3.81/6/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 6, 135°, Tube
1888390000	LSF-SMT3.81/6/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
100515000	1.05.01.170.04/0/405.4.5	max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 6, 135°, Tape
1885450000	LSF-SMT3.81/6/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1000400000	LOT CMT2 04/6/425 4 5D	max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 6, 135°, Tube
1888490000	LSF-SMT3.81/6/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1885930000	LSF-SMT3.81/7/135 3.5	max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 6, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping range,
1003930000	LSF-SWI13.61/1/133 3.5	max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 7, 135°, Tube
1888400000	LSF-SMT3.81/7/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1000+00000	EGI -GW10.01/1/100 0.010	max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 7, 135°, Tape
1885460000	LSF-SMT3.81/7/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 7, 135°, Tube
1888500000	LSF-SMT3.81/7/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 7, 135°, Tape
1885940000	LSF-SMT3.81/8/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 8, 135°, Tube
1888410000	LSF-SMT3.81/8/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 8, 135°, Tape
1885470000	LSF-SMT3.81/8/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1000510000	1.05.0NT0.04/0/405.4.5D	max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 8, 135°, Tube
1888510000	LSF-SMT3.81/8/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1885950000	L OE OMT2 91/0/125 2 5	max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 8, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping range,
1000900000	LSF-SMT3.81/9/135 3.5	max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 9, 135°, Tube
1888420000	LSF-SMT3.81/9/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1000-120000	LOI -0W10.01/9/100 0.0IX	max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 9, 135°, Tape
1885480000	LSF-SMT3.81/9/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
100010000	201 011110.0110110011.0	max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 9, 135°, Tube
1888520000	LSF-SMT3.81/9/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 9, 135°, Tape
1885960000	LSF-SMT3.81/10/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 10, 135°, Tube
1888430000	LSF-SMT3.81/10/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 10, 135°, Tape
1885490000	LSF-SMT3.81/10/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
400050000	LOE CMT2 04/40/425 4 5D	max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 10, 135°, Tube
1888530000	LSF-SMT3.81/10/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1885970000	LSF-SMT3.81/11/135 3.5	max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 10, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping range,
1003370000	LGI -GIVIT J.O 1/11/130 3.0	max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 11, 135°, Tube
1888440000	LSF-SMT3.81/11/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1000170000	23. 3.11.10.3.717.100 0.010	max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 11, 135°, Tape
		,

400==40000	105 0145 0444405 4.5	
1885510000	LSF-SMT3.81/11/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 11, 135°, Tube
1888540000	LSF-SMT3.81/11/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 11, 135°, Tape
1885980000	LSF-SMT3.81/12/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 12, 135°, Tube
1885520000	LSF-SMT3.81/12/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 12, 135°, Tube
1885990000	LSF-SMT3.81/13/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 13, 135°, Tube
1885530000	LSF-SMT3.81/13/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
100000000	1.05.01.170.0444405.0.5	max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 13, 135°, Tube
1886000000	LSF-SMT3.81/14/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
4005540000	LOE ONTO ON MANOE A.F.	max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 14, 135°, Tube
1885540000	LSF-SMT3.81/14/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1006010000	LOT CMT2 04/45/425 2 5	max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 14, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range,
1886010000	LSF-SMT3.81/15/135 3.5	max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 15, 135°, Tube
1885550000	LSF-SMT3.81/15/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
100000000	LSF-SW13.61/15/135 1.5	max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 15, 135°, Tube
1886020000	LSF-SMT3.81/16/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1000020000	EGI -GW13.01/10/103 3.3	max.: 1.5 mm ² , Pitch: 3.81 mm, No. of poles: 16, 135°, Tube
1885560000	LSF-SMT3.81/16/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 16, 135°, Tube
1886030000	LSF-SMT3.81/17/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 17, 135°, Tube
1885570000	LSF-SMT3.81/17/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 17, 135°, Tube
1886040000	LSF-SMT3.81/18/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 18, 135°, Tube
1885580000	LSF-SMT3.81/18/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
4000050000	LOE ONTO 04/40/405 0 5	max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 18, 135°, Tube
1886050000	LSF-SMT3.81/19/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1005500000	LOT CMT2 04/40/425 4 5	max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 19, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range,
1885590000	LSF-SMT3.81/19/135 1.5	max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 19, 135°, Tube
1886060000	LSF-SMT3.81/20/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
100000000	EGI -GW13.01/20/100 0.0	max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 20, 135°, Tube
1886070000	LSF-SMT3.81/21/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 21, 135°, Tube
1885610000	LSF-SMT3.81/21/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 21, 135°, Tube
1886080000	LSF-SMT3.81/22/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 22, 135°, Tube
1885620000	LSF-SMT3.81/22/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 22, 135°, Tube
1886090000	LSF-SMT3.81/23/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
400=00000	LOE OMTO OMBOMO	max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 23, 135°, Tube
1885630000	LSF-SMT3.81/23/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1006400000	LOT CMT2 04/04/405 0.5	max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 23, 135°, Tube
1886100000	LSF-SMT3.81/24/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 24, 135°, Tube

1885640000 LSF-SMT3.81/24/135 1.5

PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.81 mm, No. of poles: 24, 135°, Tube

